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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant:

Fung Leng Chen, et al.

Serial No.: 09/115,444

Filing Date: 7/14/98

Title: High Density Internal Ball Grid Array Integrated Circuit Package

Docket No.: TIS-25912

Examiner: Not Assigned

Art Unit: 2835

RECEIVED

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OFFICE OF PETITIONS

**PETITION FOR FILING UNDER 37 CFR 1.47
WHEN AN INVENTOR REFUSES TO SIGN
OR CANNOT BE REACHED**

Assistant Commissioner for Patents
Washington, D.C. 20231

Dear Sir:

MAILING CERTIFICATE UNDER 37 C.F.R. §1.8(A)

I hereby certify that the above correspondence is being deposited with the U.S. Postal Service as First Class Mail in an envelope addressed to: Assistant Commissioner for Patents, Washington, D.C. 20231.

Tina Rendon
Tina Rendon

11-6-98
Date

Enclosed please find a Declaration by Tina Rendon, Patent Secretary for Texas Instruments Incorporated, a copy of the cover letter sent to Salimah Hassan and the Declaration and Assignment signed by Fung Leng Chen and Chee Kiang Yew.

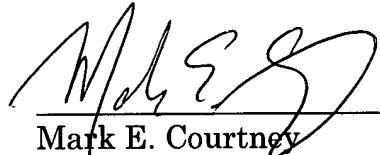
On September 8, 1998, the Declaration and Assignment forms, as filed with the subject application, and using the data set forth in the invention disclosure originally submitted by the inventors, were mailed to Salimah Hassan, secretary for Texas Instruments Singapore (PTE) Ltd.

TI Singapore has been unable to obtain the signature of Pang Hup Ong. Several attempts have been made by Texas Instruments Singapore to obtain his signature, but he has refused to sign the Declaration and Assignment.

Accordingly, application under 37 CFR 1.47 is hereby requested.

The last known address for Jing Sua Goh is listed on the attached Declaration and Assignment. Please charge the required fee under 37 CFR 1.17(h) to Deposit Account 20-0668 of Texas Instruments Incorporated.

Respectfully submitted,

A handwritten signature in black ink, appearing to read 'Mark E. Courtney', is written over a horizontal line.

Mark E. Courtney
Registration No. 36,491
Attorney for Applicants

Texas Instruments Incorporated
P.O. Box 655474 M/S 3999
Dallas, TX 75265
(972) 278-9694 or (972) 917-5632



Texas Instruments Incorporated



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8 September 1998

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VIA FEDEX 8000 9023 0443

Salimah Hassan
TEXAS INSTRUMENTS SINGAPORE (PTE) LIMITED
990 Bendemeer Road
Singapore 339942

*-Fung Leng Chen +
Chee Kiang Yew
have both signed.*

RE: **TIS-25912**
New patent application in the United States
Title: High Density Internal Ball Grid Array
Integrated Circuit Package
Inventor(s): ☒ Fung Leng Chen
☒ Chee Kiang Yew
Pang Hup Ong

*will mail Pang's copy
to you once he has
signed the document*

Salimah

Serial No: 09/115,444

Filed: 07/14/98

Dear Salimah:

Please arrange to have the enclosed Assignment and Declaration executed, as soon as conveniently possible and return to me by Express Mail no later than October 1, 1998. We have a deadline with the U.S. Patent Office.

The Assignment must be executed before a witness by an officer of TIS and by the inventor(s).

I have also enclosed a copy of the U.S. application.

Please acknowledge safe receipt of these papers by telex and advise the AIRBILL number when you return them.

Very truly yours,

Mark E. Courtney
Mark E. Courtney
TI Patent Attorney

Enclosures:

Assignment & Declaration
Specification, claims and drawings

cc: Connie Scourten



THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Fung Leng Chen, et al.

Docket No.: TIS-25912

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Art Unit: 2835

Title: High Density Internal Ball Grid Array Integrated Circuit Package

DECLARATION OF TINA RENDON

Assistant Commissioner for Patents
Washington, D.C. 20231

MAILING CERTIFICATE UNDER 37 C.F.R. §1.8(A)

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Tina Rendon
Name

11-6-98
Date

Dear Sir:

TINA RENDON declares as follows:

(1) THAT she is a secretary to Mark Courtney, the attorney in the Texas Instruments Incorporated Legal Department who handling the above-referenced application;

(2) THAT Pang Hup Ong is listed as a joint inventor with Fung Leng Chen and Chee Kiang Yew.

(3) THAT on September 8, 1998, Tina mailed the Assignment and Declaration forms to Salimah Hassan, secretary for Texas Instruments Singapore, as evidenced by the attached cover letter;

(4) THAT she has been advised by Salimah Hassan that Texas Instruments Singapore has been unable to obtain Mr. Ong's signature.

I declare under penalty of perjury that the above is true and correct.

11-6-98
Date

Tina Rendon
Tina Rendon